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Applicant(s): Reynaldo M. Rincon, et al.

Art Unit: 2858

Serial No.: 09/992,065

Examiner: TBD

Filed: 11/21/01

Docket: TI-32568

For: Dual Plane Probe Card Assembly and Method of Manufacture

LETTER TO THE OFFICIAL DRAFTSPERSON

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service on 5-8-02 as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.

Karen Vertz  
Karen Vertz

5-8-02  
Date

Assistant Commissioner for  
Patents  
Washington, D. C. 20231

Dear Sir:

Enclosed are **FOUR (4)** sheets of formal drawings for the above-referenced case. Please charge any necessary fees to Deposit Account No. 20-0668 of Texas Instruments Incorporated. This sheet is enclosed in triplicate.

Texas Instruments Incorporated  
P.O. Box 655474 M/S 3999  
Dallas, Texas 75265  
(214) 939-8651

Respectfully submitted,

Gary C. Honeycutt  
Gary C. Honeycutt  
Reg. No. 20,250  
Attorney for Applicants